

ADHESIVE SYSTEM

This application claims the benefit of Provisional application Ser. No. 60/190,533, filed Mar. 20, 2000.

The present invention relates to an adhesive system comprising an etherified amino resin, a polymer prepared from one or more ethylenically unsaturated monomers, a curing agent and a polyvinyl alcohol. The present invention also relates to the use of the adhesive system for gluing wood-based products and to a hardener composition for use in amino resin based gluing systems. Furthermore, the invention relates to a method of application of the adhesive system.

Adhesives systems suitable for use in wood-based constructions for outdoor use are generally based on formaldehyde resins, such as phenol-resorcinol-formaldehyde (PRF), phenol-formaldehyde (PF) and melamine-urea-formaldehyde (MUF). The major disadvantages of these adhesive systems are their long curing time at room temperature (~ 20 °C) and week bonding performance at temperatures below 20 °C. Typical pressing times for these systems are in the range of 5 to 24 hours at 20 °C. In addition to that, an after curing time, especially for melamine based resins, of several days is needed before the beams can be transported to the customers. These factors, of course, hamper seriously the productivity in, for example, laminated beam industries.

Furthermore, it is also known that amino resins, such as urea-formaldehyde (UF) resin, can be combined with dispersions of polymers of vinylic, acrylic, or butadiene-styrene type, in order to obtain improved bonding performance. Adhesives based merely on dispersions of polymers, like polyvinyl acetate, are not at all suitable for use in load bearing constructions. They do not meet the standards for, e.g., laminated beams. This is mainly due to their thermoplastic properties imparting creep in the construction and a poor durability.

EP 0 501 174 B1 discloses a hardening composition for urea-formaldehyde glues containing an aqueous emulsion of a polyvinyl acetate comprising post-crosslinking groups, an ammonium salt and urea. However, this hardening composition is not suitable for adhesive systems that have to be cured at room temperature, or at lower temperatures.

Thus, technical solutions are still sought for the need to find adhesive systems, which are fast curing even at room temperature or at lower temperatures and provide constructions with strong glue joints that meet the required standards for the end use products.

Accordingly, the present invention provides an adhesive system; a hardener composition suitable for use in amino resin based adhesive systems and a method of application of the adhesive system, by which the above-mentioned problems can be overcome.

The adhesive system according to the invention is defined in the appended claims. It comprises (a) an etherified amino resin, (b) a polymer prepared from one or more ethylenically unsaturated monomers, (c) a curing agent, and (d) a polyvinyl alcohol.

The etherified amino resin used in the adhesive system according to the invention, as the resin component, can be any etherified amino resin, such as etherified urea-formaldehyde, etherified melamine-urea-formaldehyde, etherified melamine-formaldehyde, or etherified melamine-urea-phenol-formaldehyde resin. Preferred etherified amino resins are etherified melamine-urea-formaldehyde and etherified melamine-formaldehyde and most preferred is etherified melamine-formaldehyde.

The term "etherified amino resin", as used herein refers to an amino resin that has been modified by reaction with an alcohol, such as methanol, ethanol or butanol. The degree of etherification can be defined by  $^{13}\text{C}$  NMR according to, e.g., the following formula:

$$\text{Degree of etherification} = \frac{\text{RNHCH}_2\text{O-CH}_3}{\text{RNHCH}_2\text{O-CH}_3 + \text{CH}_2\text{OH}} \times 100 \%$$

Suitably the etherified amino resin has a degree of etherification of 4-95 % preferably 10-75 % and most preferably 30-60 %.

The resin component in the adhesive system may be comprised of a mixture of an etherified and a non-etherified amino resin. Suitable non-etherified amino resins include urea-formaldehyde, melamine-urea-formaldehyde, melamine-formaldehyde and melamine-urea-phenol-formaldehyde.

The amount of the etherified amino resin in the resin component is suitably  $4 \geq$  weight %, preferably  $\geq 50.0$  weight %, and most preferably  $\geq 90.0$  weight %, based on the solids of the resin component.

The total amount of the resin component in the adhesive system is suitably 10-90 weight %, preferably 40-85 weight % and most preferably 50-80 weight %, based on the solids of the adhesive system.

The polymer according to the invention is suitably a homopolymer or copolymer prepared from one or more ethylenically unsaturated monomers. Examples of suitable ethylenically unsaturated monomers are vinylic monomers, such as vinyl esters, e.g., vinyl acetate, vinyl propionate, vinyl butyrate and comonomers thereof with, e.g., ethylene; alkyl esters of acrylic and methacrylic acid such as methyl acrylate, methyl methacrylate, ethyl acrylate, n-butyl acrylate, etc.; butadiene-styrene and derivatives thereof, such as carboxylated butadiene-styrene; substituted or unsubstituted mono- and dialkyl esters of alpha, beta-unsaturated dicarboxylic acids such as the substituted and

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**methylol acrylamide.**

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Mixtures of polymers containing post-crosslinking groups and polymers without post-crosslinking groups may also be used according to the invention. For example, the

polymer may comprise both polyvinyl acetate without post-crosslinking groups and vinyl acetate based polymer containing post-crosslinking groups.

Preferably the polymer according to the invention is used in a form of an aqueous dispersion.

5           Suitable curing agents include organic acids that have a rapid curing rate even at room temperature ( $\sim 20^{\circ}\text{C}$ ) and below that. Preferred organic acids include carboxylic acids, such as formic and maleic acid, and most preferably formic acid. The curing agent can be present in the adhesive system in an amount of suitably 2-40 weight-%, preferably 5-20 weight-%, and most preferably 7-15 weight-%, based on the solids of the adhesive  
10 system.

Although polyvinyl alcohol is originally present in polyvinyl acetate (PVAc) dispersions in an amount of 4-6 weight-%, it has been found according to the present invention that an extra addition of PVA into the adhesive system, beyond that originally present in the PVAc dispersion, further improves the water resistance and glue joint  
15 strength of the finished products. Suitably the polyvinyl alcohol used has a degree of hydrolysis  $> 75\%$  and can be present in the adhesive system in an amount of 0.1-20 weight %, preferably 1-10 weight %, and most preferably 3-7 weight %, based on the solids of the adhesive system. Thus, the total amount of PVA in the adhesive system, including the PVA originally present in the PVAc dispersion, could be as high as 7-14  
20 weight %, based on the solids of the adhesive system.

In a preferred embodiment of the invention the components b)-d) are mixed together into one component e), thus forming a hardener composition.

The adhesive system may also comprise fillers or other additives, such as glycol, suitable for the desired end use of the adhesive system.

25           The solids content of the adhesive system may be suitably 20-80 weight %, preferably 30-70 weight % and most preferably 45-65 weight %. The remaining part up to 100 weight % consist of water.

The term "adhesive system", as used herein means a curing formulation of a resin and a hardener component and other suitable additives.

30           The claimed invention provides for adhesive systems that give improved pressing and after curing times, water resistance and glue joint strength even when cured at room temperature or below that. These adhesives systems are suitable for gluing wood-based products and preferably wood-based products for outdoor use, for example, laminated beams, finger joints and I-beams.

35           The hardener composition according to the present invention is defined in the appended claims. It comprises (b) a polymer prepared from one or more ethylenically

unsaturated monomers, said polymer containing post-crosslinking groups, (c) a carboxylic acid and (d) a polyvinyl alcohol.

The polymer is a copolymer of one or more ethylenically unsaturated monomers and at least one monomer comprising at least one post-crosslinking group.

5        Suitable ethylenically unsaturated monomers and monomers comprising post-crosslinking groups for use in production of the polymer according to the invention are described herein above.

10        The amount of the polymer in the hardener composition is suitably 3-85 weight %, preferably 25-70 weight % and most preferably 45-65 weight %, based on the solids of the hardener composition. Preferably the polymer is used in a form of an aqueous dispersion.

The use of a carboxylic acid, which preferably is maleic or formic acid, provides a fast curing hardener composition even at room temperature, or below that.

15        Suitable amount of acid in the hardener composition is 2-50 weight %, preferred 10-50 weight % and most preferred 20-35 weight %, based on the solids of the hardener composition.

20        Preferably, a polyvinyl alcohol with a degree of hydrolysis of > 75 % is used. It is present in an amount of 0.1-40 weight %, preferably 4-30 weight % and most preferably 8-15 weight %, based on the solids of the hardener composition. The addition of extra polyvinyl alcohol, beyond that which originally may be present in, e.g., a PVAc based aqueous polymer dispersion, provides for further improved water resistance and adhesion properties of the adhesive systems where the claimed hardener composition is used.

25        If desired the hardener composition may also comprise fillers or other additives, such as glycol, suitable for the desired end use of the hardener composition.

The solids content of the hardener composition may be suitably 5-80 weight %, preferably 10-60 weight % and most preferably 30-50 weight %. The remaining part up to 100 weight % consist of water.

30        The term "solids" (of the adhesive system and the hardener composition) as used herein also includes the weight of the pure acid used as a curing agent, even in case the curing agent is a volatile acid, like formic acid.

The claimed hardener composition is suitable for use in formulating adhesive compositions based on amino resins, resulting in water and creep resistant adhesives systems, which provide for constructions with strong adhesive joints.

35        Although liquid adhesive systems, i.e., the resin and the hardener components are in liquid form, are preferred according to the invention, pulverous adhesive systems,

i.e., the resin and/or the hardener components is/are in a pulverous form, may also be used if so desired.

The method of application of the adhesive system components according to the claimed invention is defined in the appended claims.

5 According to one preferred embodiment of this method each of the components of the adhesive system, a) – d) is applied separately onto the surface to be glued.

According to another preferred embodiment component a) is applied separately and components b)-d) are mixed before application and applied as one component e), the hardener composition, onto the surface to be glued.

10 In a further preferred embodiment all of the components a) –d) are mixed together at the moment of application and applied as one component onto the surface to be glued.

In the method of the present invention, the resin and the hardener components can be applied in any order in the form of strands or by means of spraying or by means of  
15 a curtain, more suitably, the resin and hardener are applied in the form of strands, or, alternatively, the hardener composition can be applied by means of spraying and the resin in the form of strands, wherein the hardener composition in either case, preferably is applied following the application of the resin. Preferably they are both applied in the form of strands.

20 Suitable amounts of the components to be applied can be in the range of 100-500 g/m<sup>2</sup> depending, inter alia, on the feeding rate.

Suitable devices and applications forms that can be used in the method according to the present invention for the application in the form of strands of both the resin and the hardener components, are disclosed in WO 99/67027, WO 99/67028 and  
25 WO 99/67341, which are hereby incorporated herein by reference.

The invention is further illustrated by means of the following non-limiting examples. Parts and percentages relate to parts by weight and percent by weight, respectively, unless otherwise stated.

#### Examples

30 In the examples according to the invention as component a) an etherified melamine-formaldehyde (EMF) resin with an etherification degree of 46 % and with a solids content of 68-72 % was used. In the comparison examples as component a) a non-etherified melamine-formaldehyde (MF) resin with a solids content of 63-68 % was used. Two different aqueous dispersions were used, one based on a polyvinyl acetate polymer  
35 containing post-crosslinking groups (PVAc-X) and one based on a conventional polyvinyl acetate polymer without post-crosslinking groups (PVAc).

Example 1: The composition of the hardener used is given below in table 1. The resin component used was etherified MF.

Table 1

| Component         | Weight % based on the total weight of the hardener composition |
|-------------------|--|
| PVAc-X dispersion | 22 %   |
| Formic acid       | 11 %   |
| Polyvinyl alcohol | 5 %  |
| Water             | 62 %   |

- 5 Example 2 (comparison): The same hardener composition as in example 1 was used and the resin component used was non-etherified MF.

Example 3: The composition of the hardener used is given below in table 2.

Table 2

| Component         | Weight % based on the total weight of the hardener composition |
|-------------------|--|
| PVAc-X dispersion | 27 %   |
| Formic acid       | 11 %   |
| Polyvinyl alcohol | 0 %  |
| Water             | 62 %   |

- 10 Example 4 (comparison): The same hardener composition as in example 3 was used and the resin component used was non-etherified MF.

Example 5: The composition of the hardener used is given below in table 3. The resin component used was etherified MF.

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Table 3

| Component         | Weight % based on the total weight of the hardener composition |
|-------------------|--|
| PVAc              | 27 %   |
| Formic acid       | 11 %   |
| Polyvinyl alcohol | 0 %  |
| Water             | 62 %   |

Example 6 (comparison): The same hardener composition as in example 5 was used and the resin component used was non-etherified MF.

### Table 4

| Component         | Weight % based on the total weight of the hardener composition |
|-------------------|--|
| PVAc dispersion   | 22 %   |
| Formic acid       | 11 %   |
| Polyvinyl alcohol | 5 %  |
| Water             | 62 %   |

5      Example 8 (comparison): The same hardener composition as in example 7 was used and the resin component used was non-etherified MF.

The resin and the hardener components of the adhesive systems of the above described examples were separately applied, in a mixing ratio of 1:1, on 90 cm x 15,5 cm pieces of spruce and in an amount of 350 g/m<sup>2</sup>. Thereafter laminates were formed from the pieces, which were pressed at a temperature of 20 °C, a pressure of 8 bar and a relative humidity of 60 % for 2 hours. After 36 hours of after curing time the laminates were tested for delamination according to the EN 391 B standard. The results are shown in table 5 below.

### Table 5

| Adhesive system according to | Delamination |
|------------------------------|--------------|
| Example 1                    | 0.3 %        |
| Example 2                    | 0.61 %       |
| Example 3                    | 9.7 %        |
| Example 4                    | 14.1 %       |
| Example 5                    | 30.5 %       |
| Example 6                    | 82.1 %       |
| Example 7                    | 10.0 %       |
| Example 8                    | 28.2 %       |

  

Evidently the claimed adhesive systems provide for improved glue joints in relation to prior art adhesive systems.